

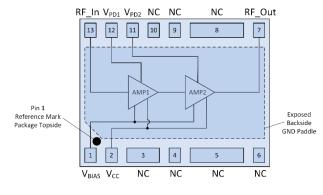
## **General Description**

The TQP9309 is a high-efficiency two-stage power amplifier in a low-cost surface-mount package with on-chip bias control and temperature compensation circuitry, suitable for small cell base station applications.

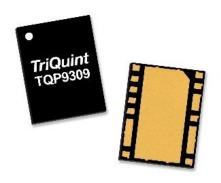
TQP9309 provides 32 dB gain and >+28 dBm linear power with pre-distortion correction over the 0.7-1.0 GHz frequency range for Bands 5, 6, 8, 12, 13, 14, 17, 20, 26, 27, 28, and 29. With pre-distortion, the amplifier is able to achieve -50dBc ACLR at 28 dBm output power using a 20 MHz LTE signal.

The TQP9309 integrates two high performance amplifier stages onto a module to allow for a compact system design and requires very few external components for operation. The amplifier is bias adjustable allowing the amplifier's power consumption to be optimized. The TQP9309 is available in a lead-free RoHS-compliant 3.5x4.5mm surface mount package and is pin-compatible to the 1.8-2.2 GHz TQP9321 and 2.5-2.7 GHz TQP9326.

# **Functional Block Diagram**



Top View



3.5 x 4.5 mm Leadless SMT Package

### **Product Features**

- Frequency Range: 0.7-1.0 GHz
- · Covers multiple bands with one component
- Fully integrated, 2-stage Power Amplifier
- Internally matched 50 Ω input/output
- -50dBc ACLR (DPD corrected) @ +28 dBm Pavg
- 32 dB Gain
- 27% PAE @ +28 dBm Pavg
- In-built Control Bias and Temp. Comp Circuit
- Single Supply Voltage: 5V
- · Lead-free / RoHS compliant
- POE Capable

# **Applications**

- Small-Cell Base Stations
- Enterprise Femtocell
- Bands 5, 6, 8, 12, 13, 14, 17, 20, 26, 27, 28, 29

# **Ordering Information**

Part No.	Description
TQP9309TR13	2500 pieces on a 13" reel
TQP9309EVB-01	Evaluation Board



# **Absolute Maximum Ratings**

Parameter	Rating
Storage Temperature	−40 to +150 °C
Supply Voltage (Vcc)	+6 V
RF Input Power, CW, 50 Ω, T=25 °C	+10 dBm

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability.

# **Recommended Operating Conditions**

Parameter	Min	Тур	Max	Units
Device Voltage (V <sub>DD</sub> )		+5		V
TCASE	-40	+25	+85	°C
Tj for >10 <sup>6</sup> hours MTTF			+190	°C

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions

# **Electrical Specifications**

Test conditions unless otherwise noted:  $V_{CC}$  =+5V, Vpd = +5V, Temp= +25°C, Test Frequency: 900MHz

Parameter	Conditions	Min	Тур	Max	Units
Operational Frequency Range		700		960	MHz
Output Channel Power			+28		dBm
Gain	700 - 800MHz	28.6	31		dB
Gain	800 - 960MHz	29.6	32	33.3	dB
Gain Temperature Coefficient			-0.026		dB/°C
ACLR Uncorrected	See note 1		-37		dBc
ACLR DPD Corrected	See note 1		-50		dBc
Power Added Efficiency	See note 1		27		%
Noise Figure			4		dB
Output P3dB		+33.9	+35		dBm
P3dB Temperature Coefficient			-0.005		dBm/°C
Supply Voltage			5		V
Quiescent Current, Icq		85	100	127	mA
Operational Current, Icc			380		mA
VSWR Survivability	Pout = +26 dBm Signal : WCDMA 1C, PAR = 8 dB	7:1			_
Thermal Resistance, θ <sub>jc</sub>	Module (junction to backside paddle)		28.3		°C/W

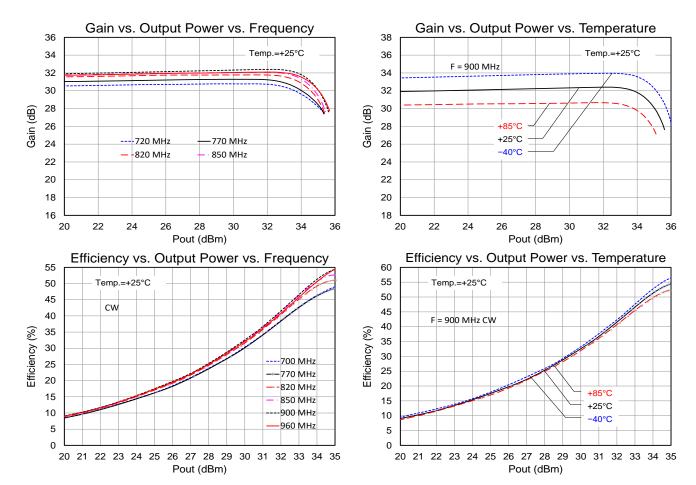
### Notes:

- 1. Using LTE signal, 20MHz, IBW = 18.02 MHz, PAR 7.5dB, Pout = +28 dBm
- 2. Items in min/max columns in **bold** at guaranteed by production test at 900 MHz
- 3. Items in min/max columns that are not a bold font are guaranteed by design characterization.



# **Performance Plots**

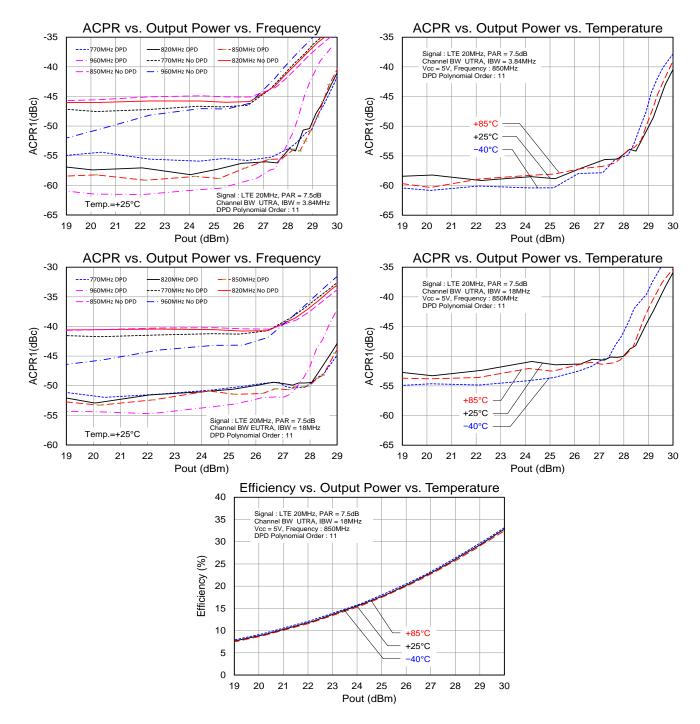
Test conditions unless otherwise noted:  $V_{CC} = +5V$ , Vpd = +5V,  $Temp = +25^{\circ}C$ 





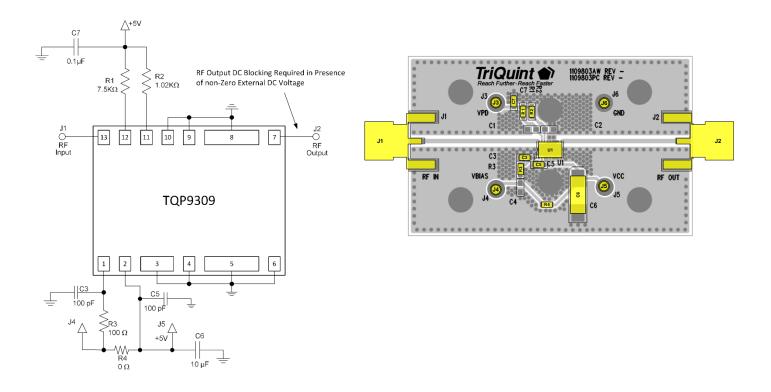
# **Performance Plots (continued)**

Test conditions unless otherwise noted:  $V_{CC} = +5V$ , Vpd = +5V,  $Temp = +25^{\circ}C$ 





# **Application Circuit - TQP9309EVB-01**

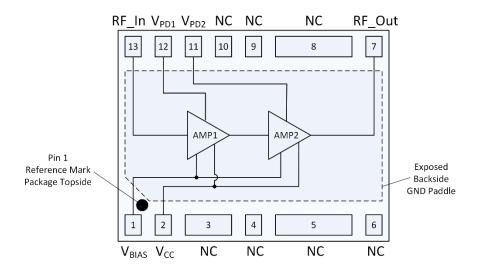


## Bill of Material - TQP9309EVB-01

Reference Des.	Value	Description	Manuf.	Part Number
n/a	n/a	Printed Circuit Board	-	1109803
U1	n/a	High Efficiency 2-stage PA	Qorvo	TQP9309
R3, R4	0 Ω	Resistor, Chip, 0603, 5%	various	
R3	100 Ω	Resistor, Chip, 0603, 5%, 1/16W	various	
C7	0.1 μF	Capacitor, Chip, 0603, 5%	various	
C6	10 μF	Capacitor, Chip, 6032, 10%, Tantalum	various	
C3, C5	100 pF	Capacitor, Chip, 0603, NPO/COG, 5%	various	
R2	1.0 ΚΩ	Resistor, Chip, 0603, 5%, 1/16W	various	
R1	7.5 KΩ	Resistor, Chip, 0603, 5%, 1/16W	various	
C1, C2, C4		Do Not Place		



# **Pin Configuration and Description**



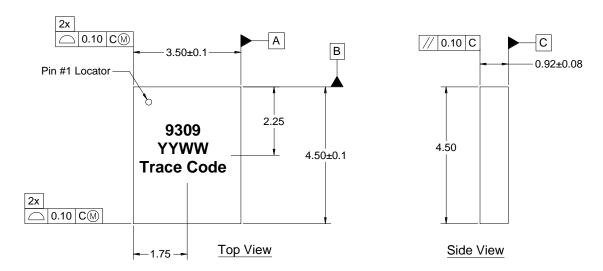
Pin No.	Label	Description
1	V <sub>BIAS</sub>	DC voltage supply input for internal active biasing circuit
2	Vcc	DC voltage supply input for AMP1 and AMP2
3, 4, 5, 6, 8, 9, 10	NC	No internal connection. Provide grounded land pads for PCB mounting integrity
7	RF_Out	RF output, DC blocking required in the presence of external non-zero DC voltage
11	V <sub>PD2</sub>	DC voltage input, AMP2 quiescent current reference, 0 Volt AMP2 power down
12	V <sub>PD1</sub>	DC voltage input, AMP1 quiescent current reference, 0 Volt AMP1 power down
13	RF_In	RF input, Internally DC blocked
Backside Paddle	-	RF & DC ground. Use recommended via hole pattern to minimize inductance and thermal resistance; see PCB Mounting Pattern for suggested footprint.

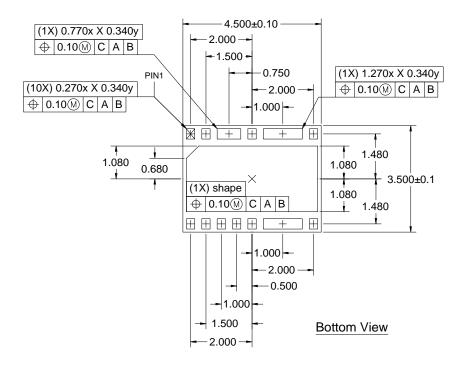


## **Mechanical Information**

## **Package Marking and Dimensions**

Marking: Part number – 9309 Assembly Code - YYWW





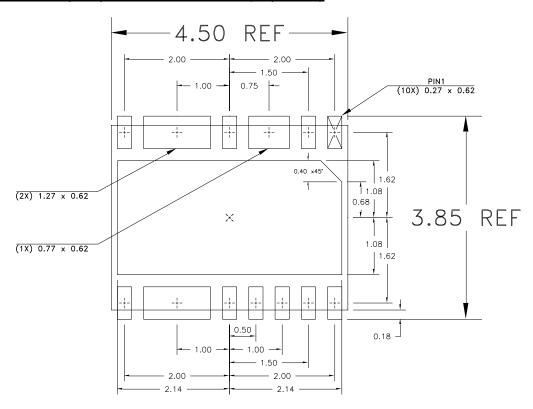
#### Notes:

- 1. All dimensions are in millimeters. Angles are in degrees.
- 2. Dimension and tolerance formats conform to ASME Y14.4M-1994.
- 3. The terminal #1 identifier and terminal numbering conform to JESD 95-1 SPP-012.

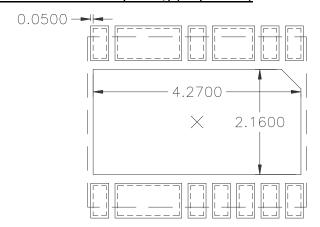


# **PCB Mounting Pattern**

### Recommend PCB land-pad pattern metallization (Top View)



### Recommended PCB solder mask opening (Top View)



#### Notes:

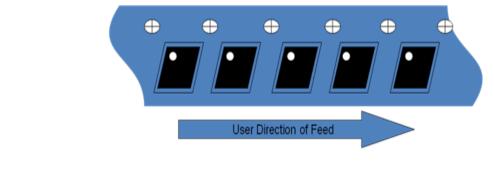
- 1. A heat sink underneath the area of the PCB for the mounted device is strictly required for proper thermal operation. Damage to the device can occur without the use of one.
- 2. Ground / thermal vias are critical for the proper performance of this device. Vias should use a .35mm (#80 / .0135") diameter drill and have a final plated thru diameter of .25 mm (.010").
- 3. Add as much copper as possible to inner and outer layers near the part to ensure optimal thermal performance.

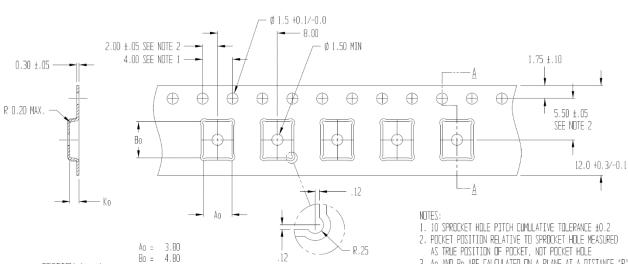


3. AO AND BO ARE CALCULATED ON A PLANE AT A DISTANCE "R"

ABOVE THE BOTTOM OF THE POCKET.

# **Tape and Reel Information – Carrier and Cover Tape Dimensions**





Feature	Measure	Symbol	Size (in)	Size (mm)
	Length	A0	0.150	3.80
0	Width	В0	0.199	4.80
Cavity	Depth	K0	0.049	1.24
	Pitch	P1	0.315	8.00
Centerline	Cavity to Perforation - Length Direction	P2	0.079	2.00
Distance	Cavity to Perforation - Width Direction	F	0.217	5.50
Cover Tape	Width	С	0.362	9.20
Carrier Tape	Width	W	0.472	12.00

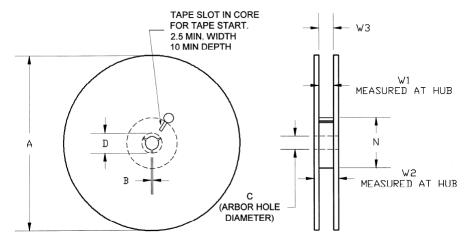
SECTION A - A

Ko = 1.24



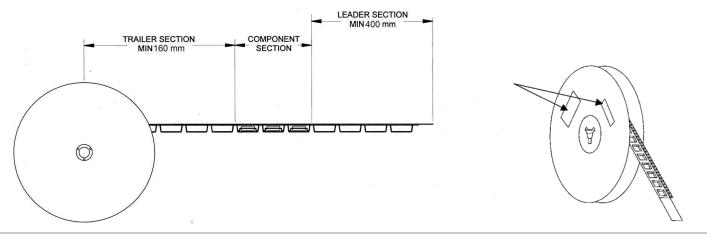
# Tape and Reel Information – Reel Dimensions (13")

Standard T/R size = 2,500 pieces on a 13" reel.



Feature	Measure	Symbol	Size (in)	Size (mm)
	Diameter	Α	12.992	330.0
Flange	Thickness	W2	0.717	18.2
Space E	Space Between Flange	W1	0.504	12.8
Hub	Outer Diameter	N	4.016	102.0
	Arbor Hole Diameter	С	0.512	13.0
	Key Slit Width	В	0.079	2.0
	Key Slit Diameter	D	0.787	20.0

# Tape and Reel Information - Tape Length and Label Placement



#### Notes

- 1. Empty part cavities at the trailing and leading ends are sealed with cover tape. See EIA 481-1-A.
- 2. Labels are placed on the flange opposite the sprockets in the carrier tape.



## **Handling Precautions**

Parameter	Rating	Standard
ESD-Human Body Model (HBM)	Class 2	ESDA / JEDEC JS-001-2012
ESD-Charged Device Model (CDM)	Class C3	JEDEC JESD22-C101F
MSL-Moisture Sensitivity Level	Level 3	IPC/JEDEC J-STD-020



Caution! ESD-Sensitive Device

## **Solderability**

Compatible with both lead-free (260°C max. reflow temp.) and tin/lead (245°C max. reflow temp.) soldering processes.

Solder profiles available upon request.

Contact plating: Electrolytic plated Au over Ni

## **RoHS Compliance**

This part is compliant with 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment) as amended by Directive 2015/863/EU.

This product also has the following attributes:

- · Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C<sub>15</sub>H<sub>12</sub>Br<sub>4</sub>O<sub>2</sub>) Free
- PFOS Free



### **Contact Information**

For the latest specifications, additional product information, worldwide sales and distribution locations:

Tel: 1-844-890-8163
Web: <u>www.qorvo.com</u>

Email: customer.support@gorvo.com

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